

Transient Voltage Suppressors for ESD Protection

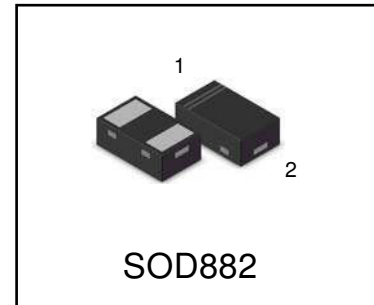
General Description

The LESD8D7.0CBT5G is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium.

Applications

- Cellular phones
- Portable devices
- Digital cameras
- Power supplies

LESD8D7.0CBT5G



ORDERING INFORMATION

| Device | Marking | Shipping |
|----------------|---------|-------------------|
| LESD8D7.0CBT5G | R5 | 10000/Tape & Reel |

Features

- Small Body Outline Dimensions
- Low Body Height
- Peak Power up to 160 W @ 8 x 20μs Pulse
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 per Human Body Model
- IEC61000 -4-2 Level 4 ESD Protection
- IEC61000 -4-4 Level 4 EFT Protection
- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- Moisture Sensitivity Level-----Level 1

Absolute Ratings (T_{amb}=25°C)

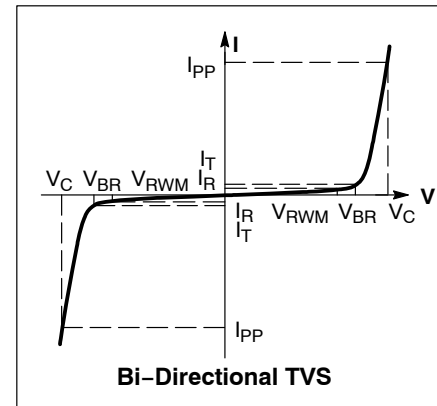
| Symbol | Parameter | Value | Units |
|------------------|---|--|-------|
| P _{PP} | Peak Pulse Power (t _p = 8/20μs) | 160 | W |
| T _L | Maximum lead temperature for soldering during 10s | 260 | °C |
| T _{stg} | Storage Temperature Range | -55 to +150 | °C |
| T _{op} | Operating Temperature Range | -40 to +125 | °C |
| T _j | Maximum junction temperature | 150 | °C |
| | IEC61000-4-2 (ESD) | air discharge ±30 contact discharge ±30 | KV |
| | IEC61000-4-4 (EFT) | 40 | A |

LESD8D7.0CBT5G

Electrical Characteristics

($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter |
|-----------|---|
| I_{PP} | Maximum Reverse Peak Pulse Current |
| V_C | Clamping Voltage @ I_{PP} |
| V_{RWM} | Working Peak Reverse Voltage |
| I_R | Maximum Reverse Leakage Current @ V_{RWM} |
| V_{BR} | Breakdown Voltage @ I_T |
| I_T | Test Current |
| P_{pk} | Peak Power Dissipation |
| C | Capacitance @ $V_R = 0$ and $f = 1.0$ MHz |

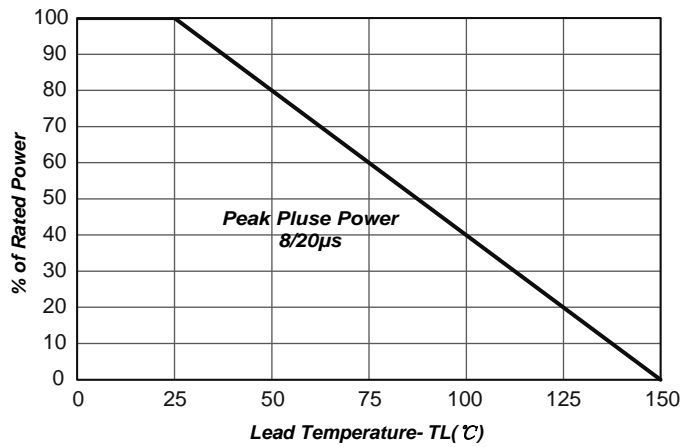
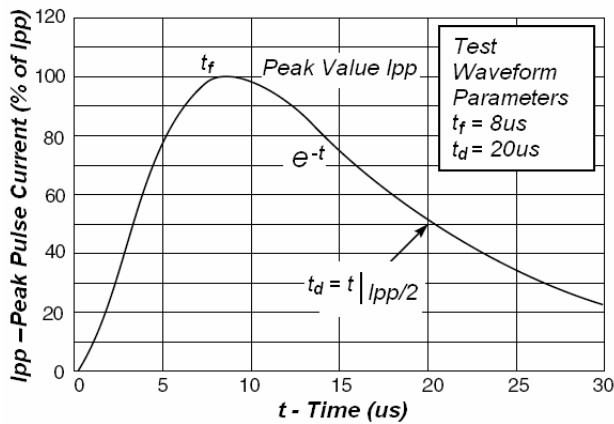


Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified. $V_F = 0.9\text{V}$ at $I_F = 10\text{mA}$

| Device | V_{RWM} (V) | I_R (uA) @ V_{RWM} | V_{BR} (V) @ I_T (Note 1) | | I_T | V_C (V) @ $I_{PP}=3\text{A}^*$ | V_C (V) @ Max I_{PP}^* | I_{PP} (A)* | P_{PK} (W)* | C (pF) |
|----------------|---------------|------------------------|-------------------------------|-----|-------|----------------------------------|----------------------------|---------------|---------------|--------|
| | Max | Max | Min | Max | mA | Max | Max | Max | Max | Typ |
| LESD8D7.0CBT5G | 7.0 | 1.0 | 7.5 | 9.5 | 1.0 | 10.5 | 13 | 12 | 160 | 35 |

*Surge current waveform per Figure 2.

- V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C .



Application Note

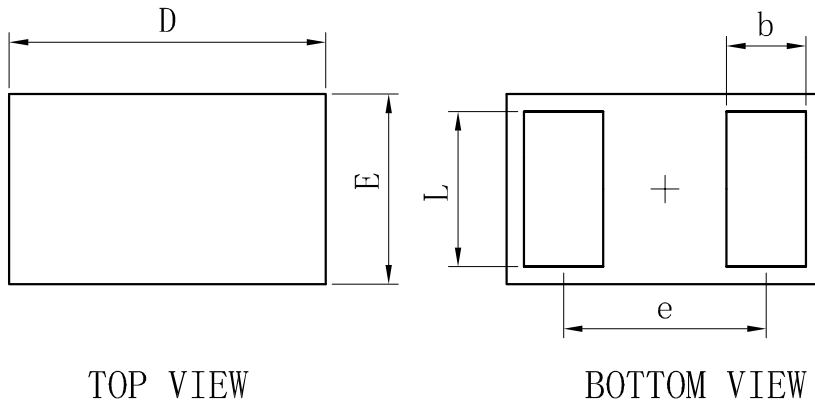
Electrostatic discharge (ESD) is a major cause of failure in electronic systems. Transient Voltage Suppressors (TVS) are an ideal choice for ESD protection. They are capable of clamping the incoming transient to a low enough level such that damage to the protected semiconductor is prevented.

Surface mount TVS offer the best choice for minimal lead inductance. They serve as parallel protection elements, connected between the signal line to ground. As the transient rises above the operating voltage of the device, the TVS becomes a low impedance path diverting the transient current to ground. The LESD8D7.0CT5G is the ideal board level protection of ESD sensitive semiconductor components.

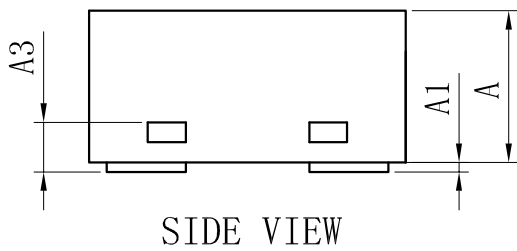
The tiny SOD882 package allows design flexibility in the design of high density boards where the space saving is at a premium. This enables to shorten the routing and contributes to hardening against ESD.

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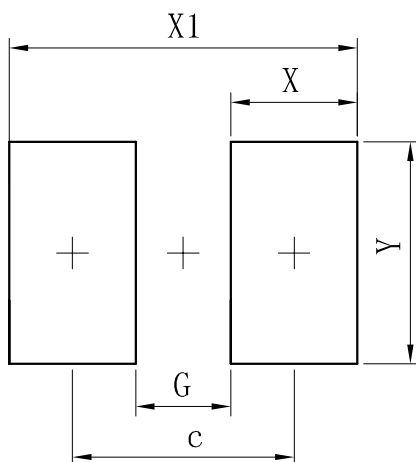
OUTLINE AND DIMENSIONS



| SOD882 | | | |
|----------------------|-----------|------|------|
| Dim | Min | Typ | Max |
| D | 0.95 | 1.00 | 1.05 |
| E | 0.55 | 0.60 | 0.65 |
| e | - | 0.64 | - |
| L | 0.44 | 0.49 | 0.54 |
| b | 0.20 | 0.25 | 0.30 |
| A | 0.43 | 0.48 | 0.53 |
| A1 | 0 | - | 0.05 |
| A3 | 0.127REF. | | |
| All Dimensions in mm | | | |



SOLDERING FOOTPRINT



| Dimensions | (mm) |
|------------|------|
| c | 0.70 |
| G | 0.30 |
| X | 0.40 |
| X1 | 1.10 |
| Y | 0.70 |